



Material Content Data Sheet



Halogen-Free

Sales Product Name	TLS835D2EL VSE	Issued	12. May 2021
MA#	MA001726784		
Package	PG-SSOP-14-5	Weight*	82.73 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.221	1.48	1.48	14760	14760
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		104	
	non noble metal	zinc	7440-66-6	0.034	0.04		416	
	non noble metal	iron	7439-89-6	0.689	0.83		8329	
	non noble metal	copper	7440-50-8	27.978	33.82	34.70	338197	347046
wire	non noble metal	copper	7440-50-8	0.075	0.09	0.09	901	901
encapsulation	organic material	carbon black	1333-86-4	0.101	0.12		1222	
	plastics	epoxy resin	-	4.649	5.62		56192	
	inorganic material	silicondioxide	60676-86-0	45.778	55.33	61.07	553365	610779
leadfinish	non noble metal	tin	7440-31-5	0.976	1.18	1.18	11799	11799
plating	noble metal	silver	7440-22-4	0.768	0.93	0.93	9279	9279
glue	plastics	epoxy resin	-	0.112	0.14		1359	
	noble metal	silver	7440-22-4	0.337	0.41	0.55	4077	5436
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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